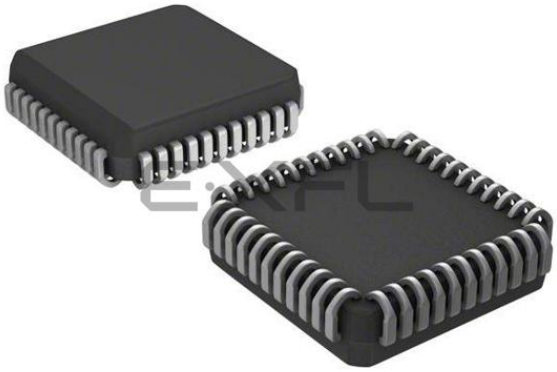


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	CANbus, I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	33
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf458t-i-l

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

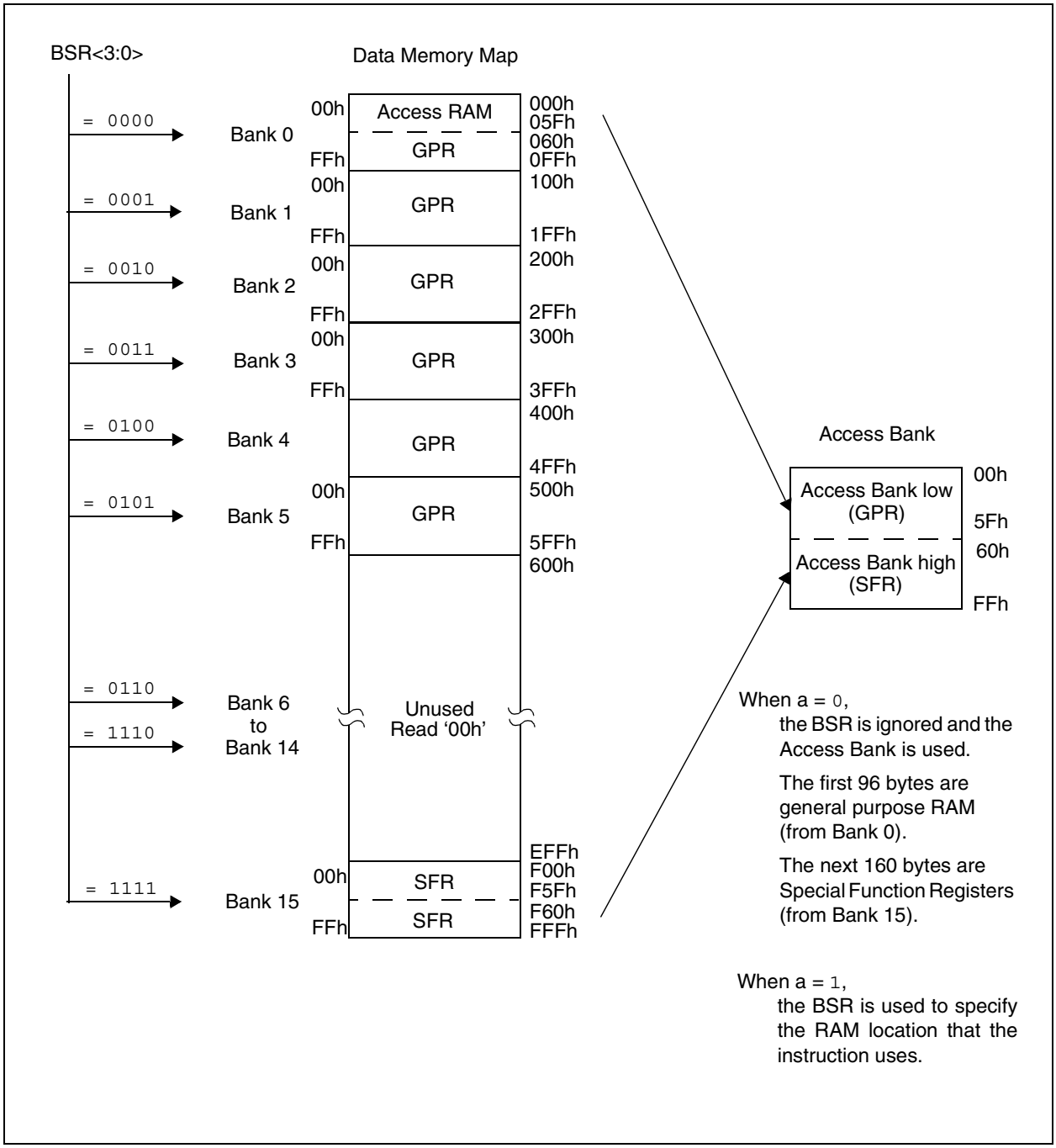
Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Trademarks

QUALITY MANAGEMENT SYSTEM
CERTIFIED BY DNV
ISO/TS 16949:2002

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona, Gresham, Oregon and Mountain View, California. The Company's quality system processes and procedures are for its PICmicro® 8-bit MCUs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

FIGURE 4-6: DATA MEMORY MAP FOR PIC18F258/458



REGISTER 8-9: PIE3: PERIPHERAL INTERRUPT ENABLE REGISTER 3

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
IRXIE	WAKIE	ERRIE	TXB2IE	TXB1IE	TXB0IE	RXB1IE	RXB0IE
bit 7							bit 0

bit 7 **IRXIE:** Invalid CAN Message Received Interrupt Enable bit
1 = Enables the invalid CAN message received interrupt
0 = Disables the invalid CAN message received interrupt

bit 6 **WAKIE:** Bus Activity Wake-up Interrupt Enable bit
1 = Enables the bus activity wake-up interrupt
0 = Disables the bus activity wake-up interrupt

bit 5 **ERRIE:** CAN bus Error Interrupt Enable bit
1 = Enables the CAN bus error interrupt
0 = Disables the CAN bus error interrupt

bit 4 **TXB2IE:** Transmit Buffer 2 Interrupt Enable bit
1 = Enables the Transmit Buffer 2 interrupt
0 = Disables the Transmit Buffer 2 interrupt

bit 3 **TXB1IE:** Transmit Buffer 1 Interrupt Enable bit
1 = Enables the Transmit Buffer 1 interrupt
0 = Disables the Transmit Buffer 1 interrupt

bit 2 **TXB0IE:** Transmit Buffer 0 Interrupt Enable bit
1 = Enables the Transmit Buffer 0 interrupt
0 = Disables the Transmit Buffer 0 interrupt

bit 1 **RXB1IE:** Receive Buffer 1 Interrupt Enable bit
1 = Enables the Receive Buffer 1 interrupt
0 = Disables the Receive Buffer 1 interrupt

bit 0 **RXB0IE:** Receive Buffer 0 Interrupt Enable bit
1 = Enables the Receive Buffer 0 interrupt
0 = Disables the Receive Buffer 0 interrupt

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

TABLE 9-1: PORTA FUNCTIONS

Name	Bit#	Buffer	Function
RA0/AN0/CVREF	bit 0	TTL	Input/output, analog input or analog comparator voltage reference output.
RA1/AN1	bit 1	TTL	Input/output or analog input.
RA2/AN2/VREF-	bit 2	TTL	Input/output, analog input or VREF-.
RA3/AN3/VREF+	bit 3	TTL	Input/output, analog input or VREF+.
RA4/T0CKI	bit 4	ST/OD	Input/output, external clock input for Timer0, output is open-drain type.
RA5/AN4/$\overline{SS}$/LVDIN	bit 5	TTL	Input/output, analog input, slave select input for synchronous serial port or Low-Voltage Detect input.
OSC2/CLKO/RA6	bit 6	TTL	Oscillator clock output or input/output.

Legend: TTL = TTL input, ST = Schmitt Trigger input, OD = Open-Drain

TABLE 9-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
PORTA	—	RA6	RA5	RA4	RA3	RA2	RA1	RA0	-00x 0000	-uuu uuuu
LATA	—	Latch A Data Output Register							-xxx xxxx	-uuu uuuu
TRISA	—	PORTA Data Direction Register							-111 1111	-111 1111
ADCON1	ADFM	ADCS2	—	—	PCFG3	PCFG2	PCFG1	PCFG0	00-- 0000	uu-- uuuu

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.

TABLE 9-5: PORTC FUNCTIONS

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit 0	ST	Input/output port pin, Timer1 oscillator output or Timer1/Timer3 clock input.
RC1/T1OSI	bit 1	ST	Input/output port pin or Timer1 oscillator input.
RC2/CCP1	bit 2	ST	Input/output port pin or Capture 1 input/Compare 1 output/ PWM1 output.
RC3/SCK/SCL	bit 3	ST	Input/output port pin or synchronous serial clock for SPI™/I^{2}C™.
RC4/SDI/SDA	bit 4	ST	Input/output port pin or SPI data in (SPI mode) or data I/O (I^{2}C mode).
RC5/SDO	bit 5	ST	Input/output port pin or synchronous serial port data output.
RC6/TX/CK	bit 6	ST	Input/output port pin, addressable USART asynchronous transmit or addressable USART synchronous clock.
RC7/RX/DT	bit 7	ST	Input/output port pin, addressable USART asynchronous receive or addressable USART synchronous data.

Legend: ST = Schmitt Trigger input

TABLE 9-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
LATC	LATC Data Output Register								xxxx xxxx	uuuu uuuu
TRISC	PORTC Data Direction Register								1111 1111	1111 1111

Legend: x = unknown, u = unchanged

15.4 PWM Mode

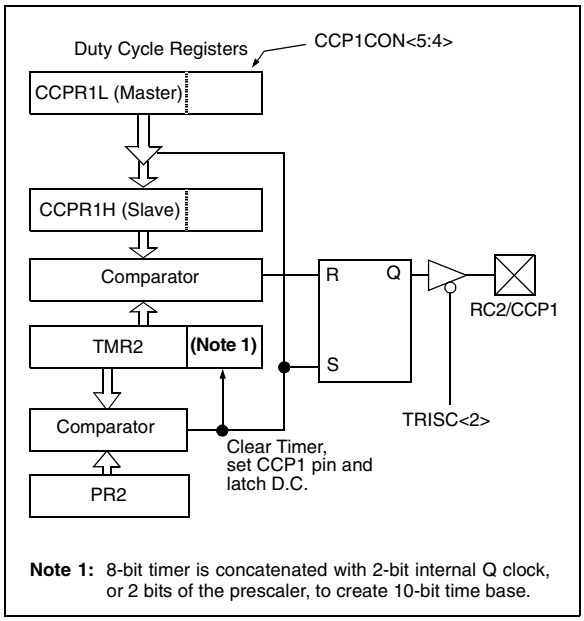
In Pulse-Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note:	Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data latch.

Figure 15-3 shows a simplified block diagram of the CCP module in PWM mode.

For a step-by-step procedure on how to set up the CCP module for PWM operation, see **Section 15.4.3 "Setup for PWM Operation"**.

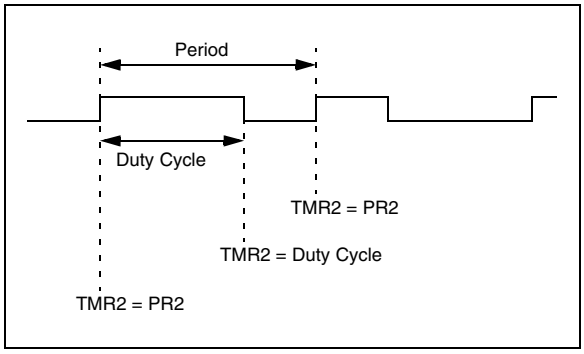
FIGURE 15-3: SIMPLIFIED PWM BLOCK DIAGRAM



Note 1: 8-bit timer is concatenated with 2-bit internal Q clock, or 2 bits of the prescaler, to create 10-bit time base.

A PWM output (Figure 15-4) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 15-4: PWM OUTPUT



15.4.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula.

EQUATION 15-1:

$$\text{PWM Period} = [(PR2) + 1] \cdot 4 \cdot T_{OSC} \cdot (\text{TMR2 Prescale Value})$$

PWM frequency is defined as 1/[PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is latched from CCPR1L into CCPR1H

Note:	The Timer2 postscaler (see **Section 13.0 "Timer2 Module"**) is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

15.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time.

EQUATION 15-2:

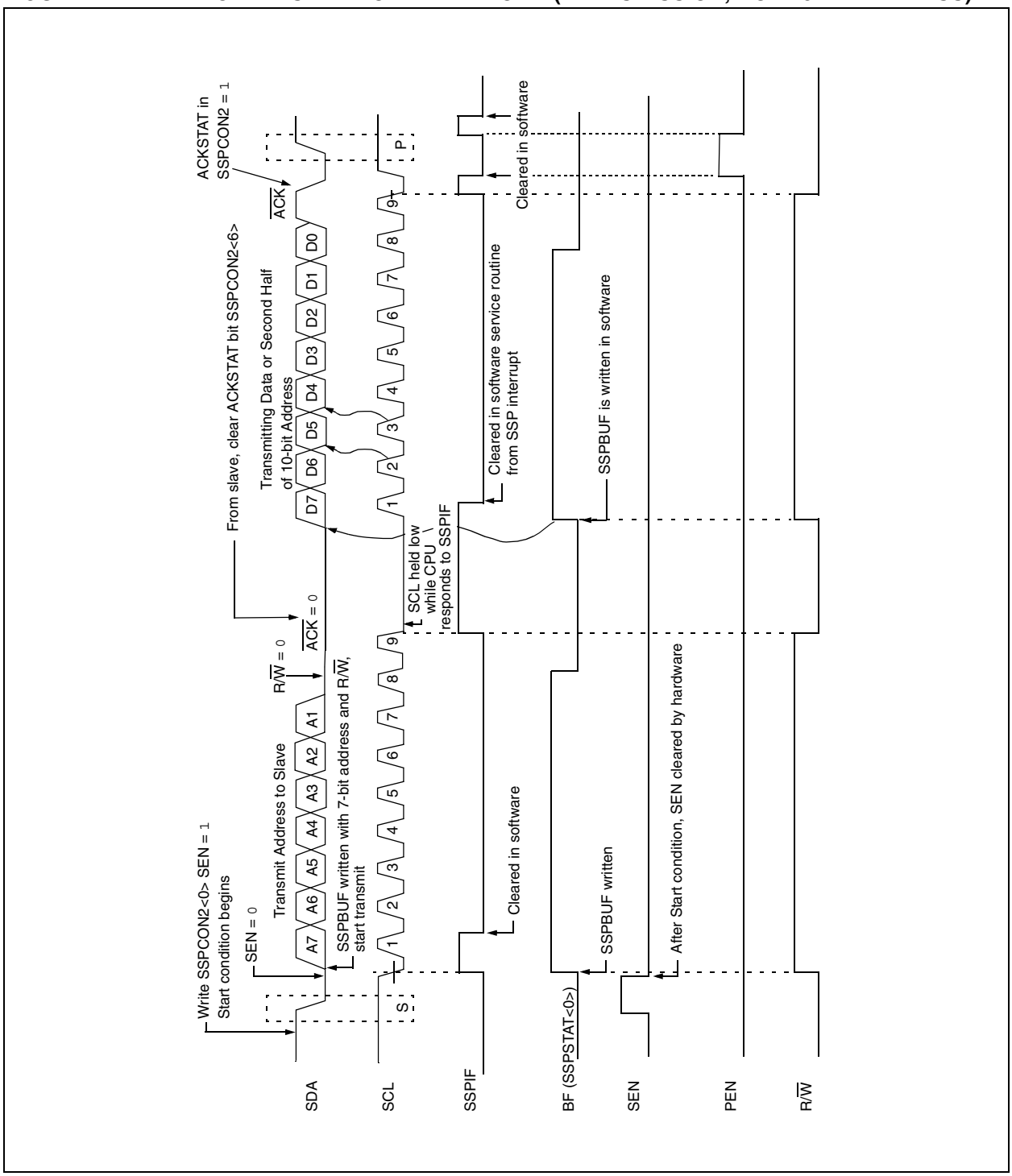
$$\text{PWM Duty Cycle} = (\text{CCPR1L:CCP1CON<5:4>}) \cdot T_{OSC} \cdot (\text{TMR2 Prescale Value})$$

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation.

When the CCPR1H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

FIGURE 17-21: I²C™ MASTER MODE WAVEFORM (TRANSMISSION, 7 OR 10-BIT ADDRESS)



17.4.17.2 Bus Collision During a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

a) A low level is sampled on SDA when SCL goes from low level to high level.

b) SCL goes low before SDA is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user deasserts SDA and the pin is allowed to float high, the BRG is loaded with SSPADD<6:0> and counts down to 0. The SCL pin is then deasserted and when sampled high, the SDA pin is sampled.

If SDA is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', Figure 17-29). If SDA is sampled high, the BRG is reloaded and begins counting. If SDA goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDA at exactly the same time.

If SCL goes from high-to-low before the BRG times out and SDA has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition (Figure 17-30).

If, at the end of the BRG time-out, both SCL and SDA are still high, the SDA pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCL pin, the SCL pin is driven low and the Repeated Start condition is complete.

FIGURE 17-29: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

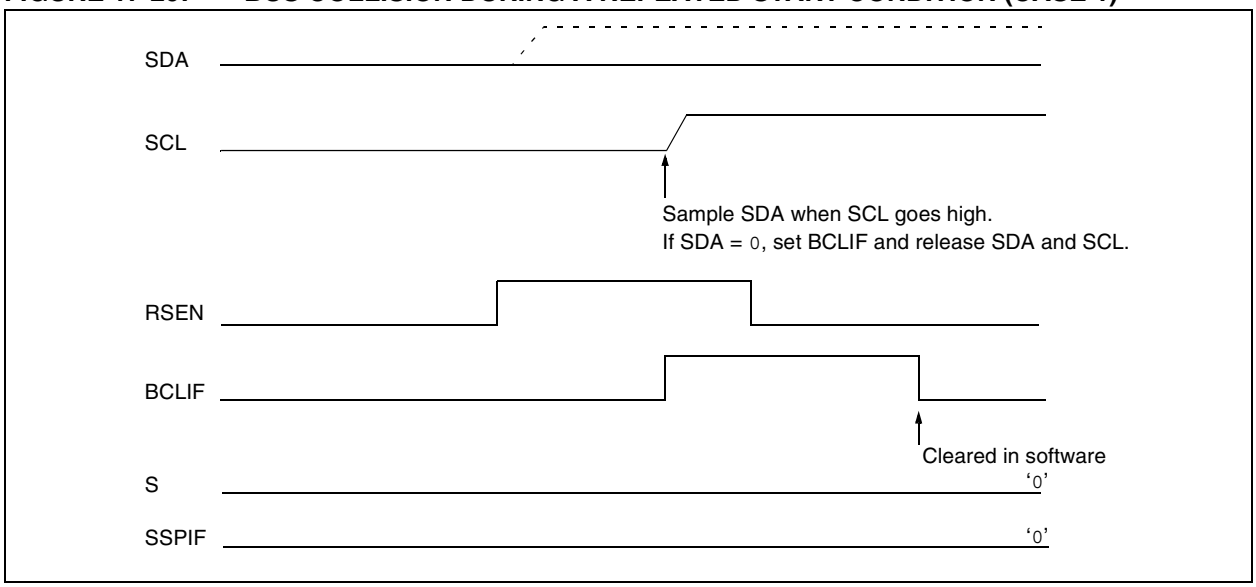
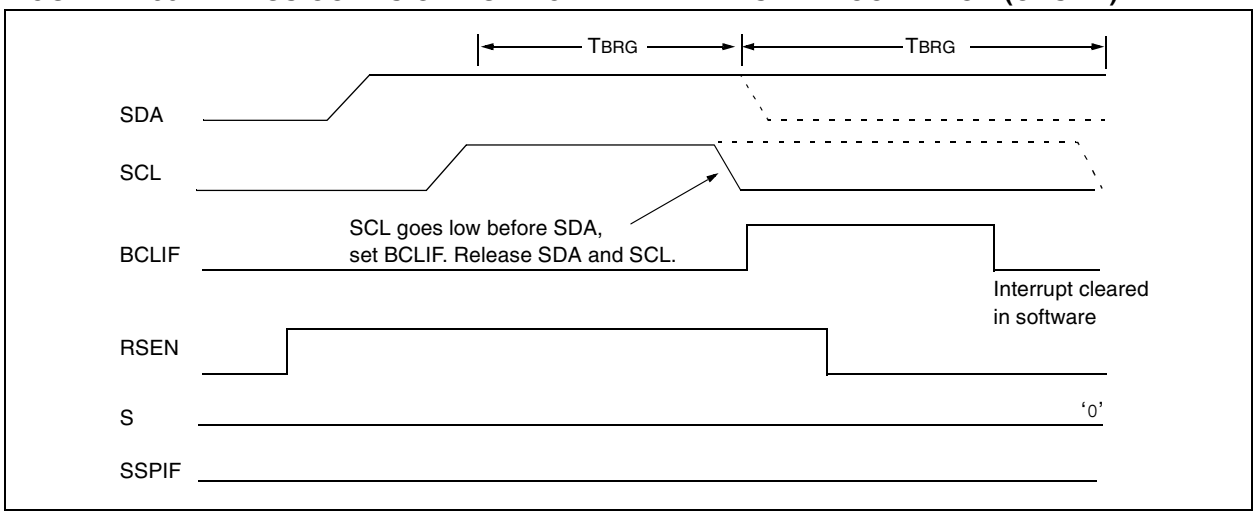


FIGURE 17-30: BUS COLLISION DURING A REPEATED START CONDITION (CASE 2)



REGISTER 18-2: RCSTA: RECEIVE STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
bit 7							bit 0

bit 7 **SPEN:** Serial Port Enable bit
1 = Serial port enabled (configures RX/DT and TX/CK pins as serial port pins)
0 = Serial port disabled

bit 6 **RX9**: 9-bit Receive Enable bit
1 = Selects 9-bit reception
0 = Selects 8-bit reception

bit 5 **SREN**: Single Receive Enable bit
Asynchronous mode:
Don't care.
Synchronous mode – Master:
1 = Enables single receive
0 = Disables single receive (this bit is cleared after reception is complete)
Synchronous mode – Slave:
Unused in this mode.

bit 4 **CREN**: Continuous Receive Enable bit
Asynchronous mode:
1 = Enables continuous receive
0 = Disables continuous receive
Synchronous mode:
1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN)
0 = Disables continuous receive

bit 3 **ADDEN**: Address Detect Enable bit
Asynchronous mode 9-bit (RX9 = 1):
1 = Enables address detection, enables interrupt and load of the receive buffer when RSR<8> is set
0 = Disables address detection, all bytes are received and ninth bit can be used as parity bit

bit 2 **FERR**: Framing Error bit
1 = Framing error (can be updated by reading RCREG register and receive next valid byte)
0 = No framing error

bit 1 **OERR**: Overrun Error bit
1 = Overrun error (can be cleared by clearing bit CREN)
0 = No overrun error

bit 0 **RX9D:** 9th bit of Received Data
Can be address/data bit or a parity bit.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

EXAMPLE 19-1: WIN AND ICODE BITS USAGE IN INTERRUPT SERVICE ROUTINE TO ACCESS TX/RX BUFFERS

```
    ; Save application required context.
    ; Poll interrupt flags and determine source of interrupt
    ; This was found to be CAN interrupt
    ; TempCANCON and TempCANSTAT are variables defined in Access Bank low
    MOVFF   CANCON, TempCANCON            ; Save CANCON.WIN bits
                                          ; This is required to prevent CANCON
                                          ; from corrupting CAN buffer access
                                          ; in-progress while this interrupt
                                          ; occurred
    MOVFF   CANSTAT, TempCANSTAT          ; Save CANSTAT register
                                          ; This is required to make sure that
                                          ; we use same CANSTAT value rather
                                          ; than one changed by another CAN
                                          ; interrupt.
    MOVF    TempCANSTAT, W                ; Retrieve ICODE bits
    ANDLW   b'00001110'
    ADDWF   PCL, F                        ; Perform computed GOTO
                                          ; to corresponding interrupt cause
    BRA     NoInterrupt                   ; 000 = No interrupt
    BRA     ErrorInterrupt                ; 001 = Error interrupt
    BRA     TXB2Interrupt                 ; 010 = TXB2 interrupt
    BRA     TXB1Interrupt                 ; 011 = TXB1 interrupt
    BRA     TXB0Interrupt                 ; 100 = TXB0 interrupt
    BRA     RXB1Interrupt                 ; 101 = RXB1 interrupt
    BRA     RXB0Interrupt                 ; 110 = RXB0 interrupt
                                          ; 111 = Wake-up on interrupt
WakeupInterrupt
    BCF     PIR3, WAKIF                   ; Clear the interrupt flag
    ;
    ; User code to handle wake-up procedure
    ;
    ;
    ; Continue checking for other interrupt source or return from here
    …
NoInterrupt
    …                                     ; PC should never vector here. User may
                                          ; place a trap such as infinite loop or pin/port
                                          ; indication to catch this error.
ErrorInterrupt
    BCF     PIR3, ERRIF                   ; Clear the interrupt flag
    …                                     ; Handle error.
    RETFIE
TXB2Interrupt
    BCF     PIR3, TXB2IF                  ; Clear the interrupt flag
    GOTO    AccessBuffer
TXB1Interrupt
    BCF     PIR3, TXB1IF                  ; Clear the interrupt flag
    GOTO    AccessBuffer
TXB0Interrupt
    BCF     PIR3, TXB0IF                  ; Clear the interrupt flag
    GOTO    AccessBuffer
RXB1Interrupt
    BCF     PIR3, RXB1IF                  ; Clear the interrupt flag
    GOTO    Accessbuffer
```

20.0 COMPATIBLE 10-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module has five inputs for the PIC18F2X8 devices and eight for the PIC18F4X8 devices. This module has the ADCON0 and ADCON1 register definitions that are compatible with the PICmicro® mid-range A/D module.

The A/D allows conversion of an analog input signal to a corresponding 10-bit digital number.

The A/D module has four registers. These registers are:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)

The ADCON0 register, shown in Register 20-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 20-2, configures the functions of the port pins.

REGISTER 20-1: ADCON0: A/D CONTROL REGISTER 0

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0
ADCS1	ADCS0	CHS2	CHS1	CHS0	GO/$\overline{\text{DONE}}$	—	ADON
bit 7							bit 0

bit 7-6 **ADCS1:ADCS0:** A/D Conversion Clock Select bits (ADCON0 bits in **bold**)

ADCON1 <ADCS2>	ADCON0 <ADCS1:ADCS0>	Clock Conversion
0	**00**	FOSC/2
0	**01**	FOSC/8
0	**10**	FOSC/32
0	**11**	FRC (clock derived from the internal A/D RC oscillator)
1	**00**	FOSC/4
1	**01**	FOSC/16
1	**10**	FOSC/64
1	**11**	FRC (clock derived from the internal A/D RC oscillator)

bit 5-3 **CHS2:CHS0:** Analog Channel Select bits
000 = Channel 0 (AN0)
001 = Channel 1 (AN1)
010 = Channel 2 (AN2)
011 = Channel 3 (AN3)
100 = Channel 4 (AN4)
101 = Channel 5 (AN5)**(1)**
110 = Channel 6 (AN6)**(1)**
111 = Channel 7 (AN7)**(1)**

Note 1: These channels are unimplemented on PIC18F2X8 (28-pin) devices. Do not select any unimplemented channel.

bit 2 **GO/$\overline{\text{DONE}}$:** A/D Conversion Status bit
When ADON = 1:
1 = A/D conversion in progress (setting this bit starts the A/D conversion which is automatically cleared by hardware when the A/D conversion is complete)
0 = A/D conversion not in progress

bit 1 **Unimplemented:** Read as '0'

bit 0 **ADON:** A/D On bit
1 = A/D converter module is powered up
0 = A/D converter module is shut-off and consumes no operating current

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

The value that is in the ADRESH/ADRESL registers is not modified for a Power-on Reset. The ADRESH/ADRESL registers will contain unknown data after a Power-on Reset.

After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 20.1 "A/D Acquisition Requirements"**. After this acquisition time has elapsed, the A/D conversion can be started. The following steps should be followed for doing an A/D conversion:

1. Configure the A/D module:
   - Configure analog pins, voltage reference and digital I/O (ADCON1)
   - Select A/D input channel (ADCON0)
   - Select A/D conversion clock (ADCON0)
   - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
   - Clear ADIF bit
   - Set ADIE bit
   - Set GIE bit
3. Wait the required acquisition time.
4. Start conversion:
   - Set GO/$\overline{\text{DONE}}$ bit (ADCON0)
5. Wait for A/D conversion to complete, by either:
   - Polling for the GO/$\overline{\text{DONE}}$ bit to be cleared

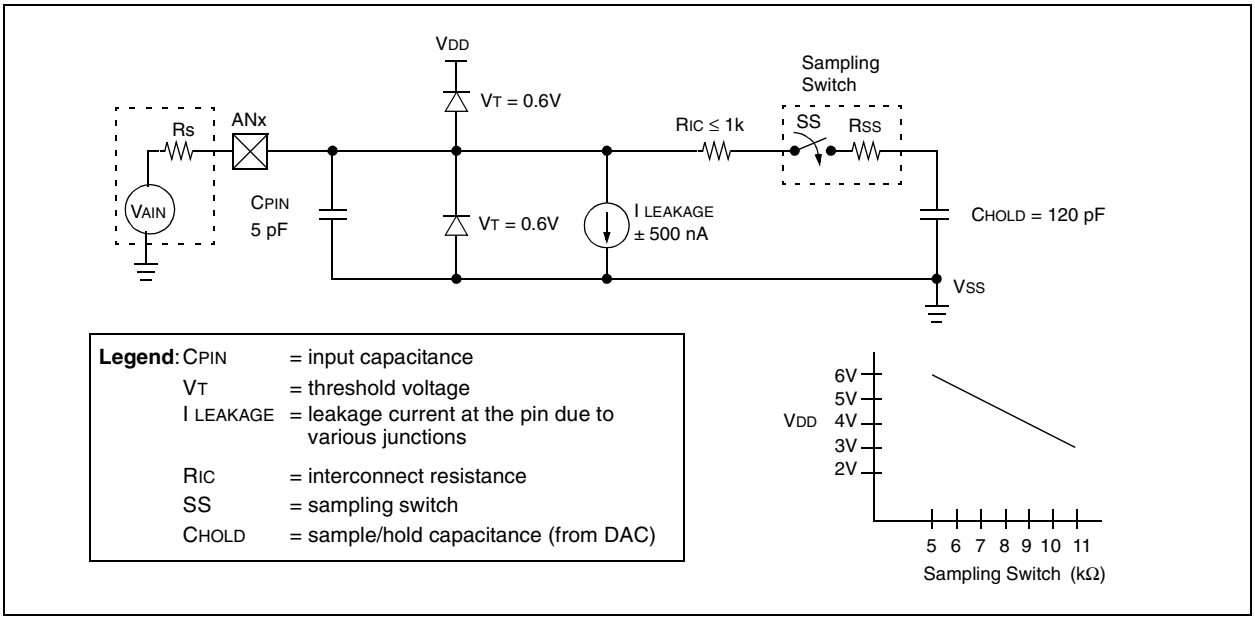
   OR
   - Waiting for the A/D interrupt
6. Read A/D Result registers (ADRESH/ADRESL); clear bit ADIF if required.
7. For next conversion, go to step 1 or step 2 as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before next acquisition starts.

20.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 20-2. The source impedance (RS) and the internal sampling switch (RSS) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (RSS) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). **The maximum recommended impedance for analog sources is 2.5 kΩ.** After the analog input channel is selected (changed), this acquisition must be done before the conversion can be started.

Note:	When the conversion is started, the holding capacitor is disconnected from the input pin.

FIGURE 20-2: ANALOG INPUT MODEL



23.1 Control Register

The Low-Voltage Detect Control register controls the operation of the Low Voltage Detect circuitry.

REGISTER 23-1: LVDCON: LOW-VOLTAGE DETECT CONTROL REGISTER

U-0	U-0	R-0	R/W-0	R/W-0	R/W-1	R/W-0	R/W-1
—	—	IRVST	LVDEN	LVDL3	LVDL2	LVDL1	LVDL0
bit 7							bit 0

bit 7-6 **Unimplemented:** Read as '0'

bit 5 **IRVST:** Internal Reference Voltage Stable Flag bit

1 = Indicates that the Low-Voltage Detect logic will generate the interrupt flag at the specified voltage range

0 = Indicates that the Low-Voltage Detect logic will not generate the interrupt flag at the specified voltage range and the LVD interrupt should not be enabled

bit 4 **LVDEN:** Low-Voltage Detect Power Enable bit

1 = Enables LVD, powers up LVD circuit

0 = Disables LVD, powers down LVD circuit

bit 3-0 **LVDL3:LVDL0:** Low-Voltage Detection Limit bits

1111 = External analog input is used (input comes from the LVDIN pin)
1110 = 4.45V min.-4.83V max.
1101 = 4.16V min.-4.5V max.
1100 = 3.96V min.-4.2V max.
1011 = 3.76V min.-4.08V max.
1010 = 3.57V min.-3.87V max.
1001 = 3.47V min.-3.75V max.
1000 = 3.27V min.-3.55V max.
0111 = 2.98V min.-3.22V max.
0110 = 2.77V min.-3.01V max.
0101 = 2.67V min.-2.89V max.
0100 = 2.48V min.-2.68V max.
0011 = 2.37V min.-2.57V max.
0010 = 2.18V min.-2.36V max.
0001 = 1.98V min.-2.14V max.
0000 = Reserved

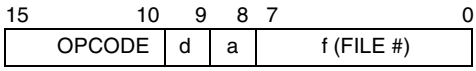
Note: LVDL3:LVDL0 modes, which result in a trip point below the valid operating voltage of the device, are not tested.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

FIGURE 25-1: GENERAL FORMAT FOR INSTRUCTIONS

Byte-oriented file register operations

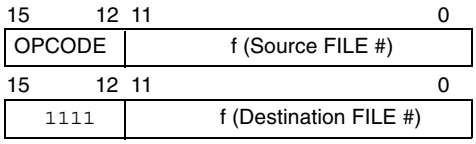
Example Instruction



ADDWF MYREG, W, B

d = 0 for result destination to be WREG register
d = 1 for result destination to be file register (f)
a = 0 to force Access Bank
a = 1 for BSR to select bank
f = 8-bit file register address

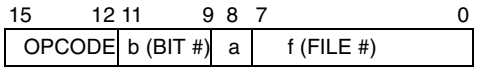
Byte to Byte move operations (2-word)



MOVFF MYREG1, MYREG2

f = 12-bit file register address

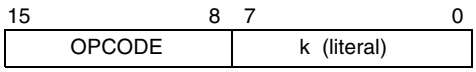
Bit-oriented file register operations



BSF MYREG, bit, B

b = 3-bit position of bit in file register (f)
a = 0 to force Access Bank
a = 1 for BSR to select bank
f = 8-bit file register address

Literal operations

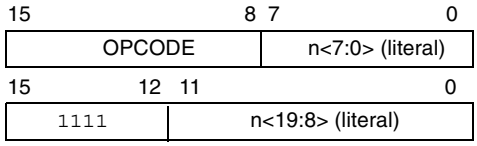


MOVLW 0x7F

k = 8-bit immediate value

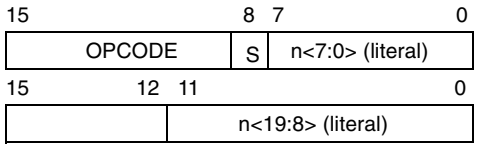
Control operations

CALL, GOTO and Branch operations



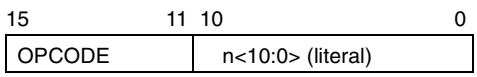
GOTO Label

n = 20-bit immediate value

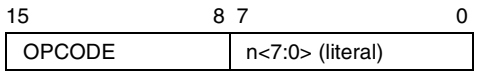


CALL MYFUNC

S = Fast bit



BRA MYFUNC



BC MYFUNC

NEGF **Negate f**

Syntax: [*label*] NEGF f [,a]

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: $(\overline{f}) + 1 \rightarrow f$

Status Affected: N, OV, C, DC, Z

Encoding:

0110	110a	ffff	ffff

Description: Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'. If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: NEGF REG, 1

Before Instruction
REG = 0011 1010 [0x3A]
After Instruction
REG = 1100 0110 [0xC6]

NOP **No Operation**

Syntax: [*label*] NOP

Operands: None

Operation: No operation

Status Affected: None

Encoding:

0000 1111	0000 xxxx	0000 xxxx	0000 xxxx

Description: No operation.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No operation	No operation	No operation

Example:

None.

26.20 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. A programmed sample is included. The PRO MATE II device programmer, or the PICSTART Plus development programmer, can be used to reprogram the device for user tailored application development. The PICDEM 17 demonstration board supports program download and execution from external on-board Flash memory. A generous prototype area is available for user hardware expansion.

26.21 PICDEM 18R PIC18C601/801 Demonstration Board

The PICDEM 18R demonstration board serves to assist development of the PIC18C601/801 family of Microchip microcontrollers. It provides hardware implementation of both 8-bit Multiplexed/Demultiplexed and 16-bit Memory modes. The board includes 2 Mb external Flash memory and 128 Kb SRAM memory, as well as serial EEPROM, allowing access to the wide range of memory types supported by the PIC18C601/801.

26.22 PICDEM LIN PIC16C43X Demonstration Board

The powerful LIN hardware and software kit includes a series of boards and three PICmicro microcontrollers. The small footprint PIC16C432 and PIC16C433 are used as slaves in the LIN communication and feature on-board LIN transceivers. A PIC16F874 Flash microcontroller serves as the master. All three microcontrollers are programmed with firmware to provide LIN bus communication.

26.23 PICkit™ 1 Flash Starter Kit

A complete “development system in a box”, the PICkit™ Flash Starter Kit includes a convenient multi-section board for programming, evaluation and development of 8/14-pin Flash PIC® microcontrollers. Powered via USB, the board operates under a simple Windows GUI. The PICkit 1 Starter Kit includes the User’s Guide (on CD ROM), PICkit 1 tutorial software and code for various applications. Also included are MPLAB® IDE (Integrated Development Environment) software, software and hardware “Tips 'n Tricks for 8-pin Flash PIC® Microcontrollers” Handbook and a USB interface cable. Supports all current 8/14-pin Flash PIC microcontrollers, as well as many future planned devices.

26.24 PICDEM USB PIC16C7X5 Demonstration Board

The PICDEM USB Demonstration Board shows off the capabilities of the PIC16C745 and PIC16C765 USB microcontrollers. This board provides the basis for future USB products.

26.25 Evaluation and Programming Tools

In addition to the PICDEM series of circuits, Microchip has a line of evaluation kits and demonstration software for these products.

- KEELOQ evaluation and programming tools for Microchip’s HCS Secure Data Products
- CAN developers kit for automotive network applications
- Analog design boards and filter design software
- PowerSmart battery charging evaluation/ calibration kits
- IrDA® development kit
- microID development and rfLab™ development software
- SEEVAL® designer kit for memory evaluation and endurance calculations
- PICDEM MSC demo boards for Switching mode power supply, high-power IR driver, delta sigma ADC and flow rate sensor

Check the Microchip web page and the latest Product Selector Guide for the complete list of demonstration and evaluation kits.

FIGURE 27-4: LOW-VOLTAGE DETECT CHARACTERISTICS

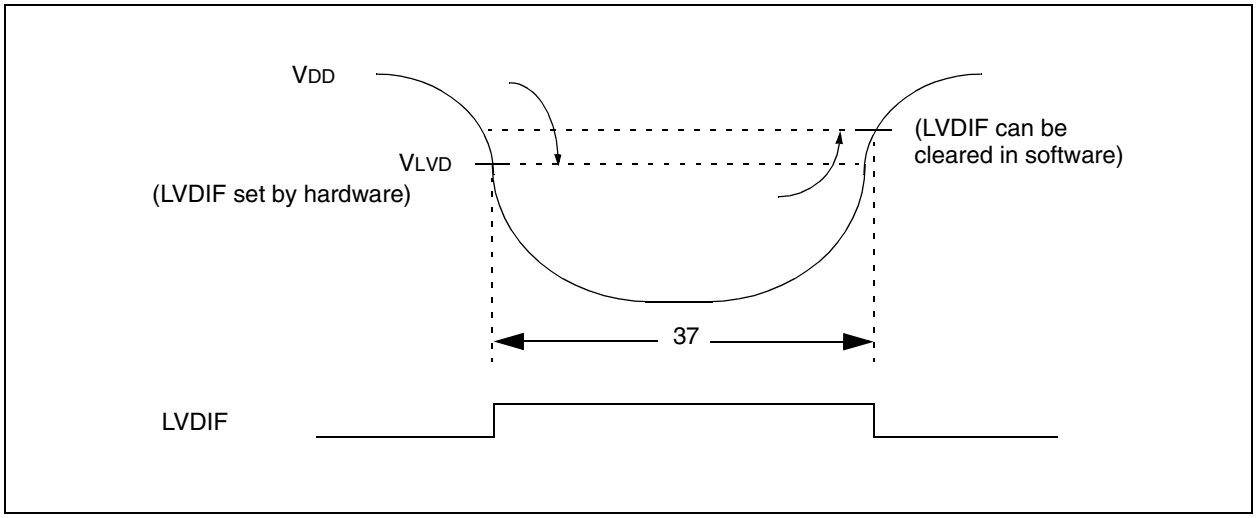


TABLE 27-1: LOW-VOLTAGE DETECT CHARACTERISTICS

Low-Voltage Detect Characteristics				Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
Param No.	**Symbol**	**Characteristic**		**Min**	**Typ**	**Max**	**Units**	**Conditions**
D420	VLVD	LVD Voltage	LVV = 0001	1.96	2.06	2.16	V	T ≥ 25°C
			LVV = 0010	2.16	2.27	2.38	V	T ≥ 25°C
			LVV = 0011	2.35	2.47	2.59	V	T ≥ 25°C
			LVV = 0100	2.43	2.58	2.69	V	
			LVV = 0101	2.64	2.78	2.92	V	
			LVV = 0110	2.75	2.89	3.03	V	
			LVV = 0111	2.95	3.1	3.26	V	
			LVV = 1000	3.24	3.41	3.58	V	
			LVV = 1001	3.43	3.61	3.79	V	
			LVV = 1010	3.53	3.72	3.91	V	
			LVV = 1011	3.72	3.92	4.12	V	
			LVV = 1100	3.92	4.13	4.34	V	
			LVV = 1101	4.07	4.33	4.59	V	
			LVV = 1110	4.36	4.64	4.92	V	

27.3.3 TIMING DIAGRAMS AND SPECIFICATIONS

FIGURE 27-6: EXTERNAL CLOCK TIMING

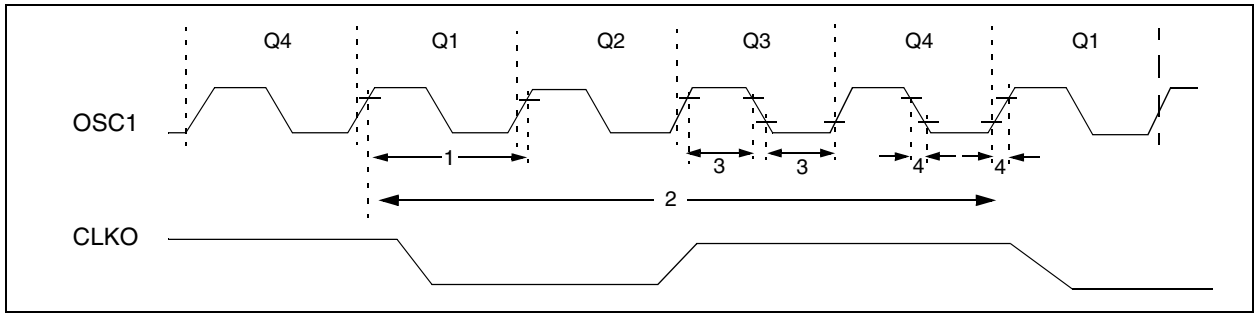


TABLE 27-6: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
1A	FOSC	External CLKI Frequency(1)	DC	40	MHz	EC, ECIO oscillator, -40°C to +85°C
		Oscillator Frequency(1)	DC	25	MHz	EC, ECIO oscillator, +85°C to +125°C
			DC	4	MHz	RC oscillator
			0.1	4	MHz	XT oscillator
			4	25	MHz	HS oscillator, -40°C to +85°C
			4	25	MHz	HS oscillator, +85°C to +125°C
			4	10	MHz	HS + PLL oscillator, -40°C to +85°C
			4	6.25	MHz	HS + PLL oscillator, +85°C to +125°C
			DC	200	kHz	LP oscillator
1	TOSC	External CLKI Period(1)	25	—	ns	EC, ECIO oscillator, -40°C to +85°C
		Oscillator Period(1)	40	—	ns	EC, ECIO oscillator, +85°C to +125°C
			250	—	ns	RC oscillator
			250	10,000	ns	XT oscillator
			40	—	ns	HS oscillator, -40°C to +85°C
			40	—	ns	HS oscillator, +85°C to +125°C
			100	250	ns	HS + PLL oscillator, -40°C to +85°C
			160	250	ns	HS + PLL oscillator, +85°C to +125°C
			5	200	µs	LP oscillator
2	TCY	Instruction Cycle Time(1)	100	—	ns	TCY = 4/FOSC, -40°C to +85°C
			160	—	ns	TCY = 4/FOSC, +85°C to +125°C
3	TosL, TosH	External Clock in (OSC1) High or Low Time	30	—	ns	XT oscillator
			2.5	—	ns	LP oscillator
			10	—	µs	HS oscillator
4	TosR, TosF	External Clock in (OSC1) Rise or Fall Time	—	20	ns	XT oscillator
			—	50	ns	LP oscillator
			—	7.5	ns	HS oscillator

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at “Min.” values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the “Max.” cycle time limit is “DC” (no clock) for all devices.

APPENDIX A: DATA SHEET REVISION HISTORY

Revision A (June 2001)

Original data sheet for the PIC18FXX8 family.

Revision B (May 2002)

Updated information on CAN module, device memory and register maps, I/O ports and Enhanced CCP.

Revision C (January 2003)

This revision includes the DC and AC Characteristics Graphs and Tables (see **Section 28.0 "DC and AC Characteristics Graphs and Tables"**), **Section 27.0 "Electrical Characteristics"** have been updated and CAN certification information has been added.

Revision D (September 2004)

Data Sheet Errata (DS80134 and DS80161) issues have been addressed and corrected along with minor corrections to the data sheet text.

Revision E (October 2006)

Packaging diagrams updated.

APPENDIX B: DEVICE DIFFERENCES

The differences between the devices listed in this data sheet are shown in Table B-1.

TABLE B-1: DEVICE DIFFERENCES

Features		PIC18F248	PIC18F258	PIC18F448	PIC18F458
Internal Program Memory	Bytes	16K	32K	16K	32K
	# of Single-Word Instructions	8192	16384	8192	16384
Data Memory (Bytes)		768	1536	768	1536
I/O Ports		Ports A, B, C	Ports A, B, C	Ports A, B, C, D, E	Ports A, B, C, D, E
Enhanced Capture/Compare/PWM Modules		—	—	1	1
Parallel Slave Port		No	No	Yes	Yes
10-bit Analog-to-Digital Converter		5 input channels	5 input channels	8 input channels	8 input channels
Analog Comparators		No	No	2	2
Analog Comparators VREF Output		N/A	N/A	Yes	Yes
Packages		28-pin SPDIP 28-pin SOIC	28-pin SPDIP 28-pin SOIC	40-pin PDIP 44-pin PLCC 44-pin TQFP	40-pin PDIP 44-pin PLCC 44-pin TQFP

O

P